

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

BECKER et al.

Confirmation No.: 8310

Application No.: 09/424,660

Group Art Unit: 1762

Filed: January 27, 2000

Examiner: K. Bareford

For:

METHOD AND DEVICE FOR CONTROLLING

THICKNESS DURING SPIN COATING (AS AMENDED)

RECEIVED

SEP 2 5 2003

TC 1700

September 17, 2003

AMENDMENT UNDER 37 C.F.R. §1.111

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In reply to the Office Action dated March 18, 2003, the period for reply being extended by a Petition for Three-Month Extension of time filed herewith, please amend the above-identified application as follows:

IN THE CLAIMS:

- 1-13. (Cancelled)
- 14. (Previously presented) A method of bonding a first planar substrate to a second planar substrate by a bonding material in the form of a viscous fluid, comprising:

pumping the viscous fluid with a dosing pump to a dosing arm connected to the dosing pump and positioned over the first substrate;

forming a layer of the viscous fluid on the first substrate by dosing the first substrate with viscous fluid from the dosing arm;

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